ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	burn, Illinois. All r	rights reserved und	ler both leve	is documer el parts, th	nt is a declaration e	on of the sub ncompasses	bstances all lower	within the manufactur r level materials for wl	er listed i hich the n	tem. Note: i nanufacture	f the item is an as r has engineering	sembly with lower responsibility.	
1752-21.1 IPC Web Site for Information on http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials an					and Mfg Information			
Supplier Information													
mpany name* Company unique ID				Unique ID Authority					Response Date*				
onsemi									2024-04-24				
Contact Name	Title - Contact			Р	Phone - Contact*				Email - Contact*				
oduct-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr Iter	n Number M	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
QEB37	QEB373GR LED T3-4 ALG		S GULLW T&R		2024-04-24		E	EVERLGFG		18.7	mg	Each	
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	1 Terminal Base Alloy		STD-020 MSL Ra	ating	Peak Proce	Process Body Temperature Max Time at Peak		Temperature Number		per of Reflow Cyc	eles		
Matte Tin (Sn) - annealed CU Alloy 2					260		С	30	secon	nds 3			
Comments													
ATTENTION: MSL 2 Rated item requires Dry Pack	after electrical tes	st)											
For more information regarding material composition	please refer to pa	age 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	inition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead ury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die 0.0	0.05	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0195	mg
			Supplier	Silicon (Si)	7440-21-3		0.0305	mg
Die Attach 0.051	0.051	51 mg	Supplier	Silver (Ag)	7440-22-4		0.0441	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0069	mg
Lead Frame 6.38	6.38	38 mg	Supplier	Silver (Ag)	7440-22-4		0.032	mg
			Supplier	Tin (Sn)	7440-31-5		0.032	mg
			Supplier	Copper (Cu)	7440-50-8		6.316	mg
Mold Compound-Black 9.00	9.009	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.505	mg
			Supplier	2,4,6-Tris[Bis(Methoxymethyl)Amino]- 1,3,5-Triazine	3089-11-0		4.504	mg
Plating	3.2	mg	Supplier	Tin (Sn)	7440-31-5		3.2	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg